

Chipsmall Limited consists of a professional team with an average of over 10 year of expertise in the distribution of electronic components. Based in Hongkong, we have already established firm and mutual-benefit business relationships with customers from, Europe, America and south Asia, supplying obsolete and hard-to-find components to meet their specific needs.

With the principle of "Quality Parts, Customers Priority, Honest Operation, and Considerate Service", our business mainly focus on the distribution of electronic components. Line cards we deal with include Microchip, ALPS, ROHM, Xilinx, Pulse, ON, Everlight and Freescale. Main products comprise IC, Modules, Potentiometer, IC Socket, Relay, Connector. Our parts cover such applications as commercial, industrial, and automotives areas.

We are looking forward to setting up business relationship with you and hope to provide you with the best service and solution. Let us make a better world for our industry!



# Contact us

Tel: +86-755-8981 8866 Fax: +86-755-8427 6832

Email & Skype: info@chipsmall.com Web: www.chipsmall.com

Address: A1208, Overseas Decoration Building, #122 Zhenhua RD., Futian, Shenzhen, China







# 1500 Watt Peak Power Littelfuse Zener Transient Voltage Suppressors

# **Unidirectional\***

These devices are designed to protect voltage sensitive components from high voltage, high-energy transients. They have excellent clamping capability, high surge capability, low zener impedance and fast response time. These devices are the Littelfuse exclusive, cost-effective, highly reliable axial leaded package and are ideally-suited for use in communication systems, numerical controls, process controls, medical equipment, business machines, power supplies and many other industrial/consumer applications, to protect CMOS, MOS and Bipolar integrated circuits.

# **Specification Features**

- Working Peak Reverse Voltage Range 5.0 V to 45 V
- Peak Power 1500 Watts @ 1 ms
- ESD Rating of Class 3 (>16 KV) per Human Body Model
- Maximum Clamp Voltage @ Peak Pulse Current
- Low Leakage < 5 μA Above 10 V
- Response Time is Typically < 1 ns
- Pb-Free Packages are Available\*

#### **Mechanical Characteristics**

**CASE:** Void-free, transfer-molded, thermosetting plastic

FINISH: All external surfaces are corrosion resistant and leads are

readily solderable

### MAXIMUM LEAD TEMPERATURE FOR SOLDERING PURPOSES:

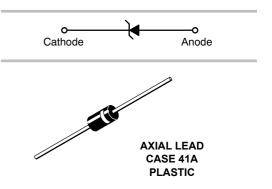
260°C, 1/16" from the case for 10 seconds

**POLARITY:** Cathode indicated by polarity band

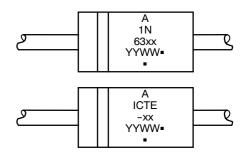
**MOUNTING POSITION:** Any



#### Littelfuse.com



#### **MARKING DIAGRAMS**



A = Assembly Location 1N63xx = JEDEC Device Code ICTE-xx = ON Device Code YY = Year

WW = Work Week
■ Pb-Free Package

(Note: Microdot may be in either location)

#### ORDERING INFORMATION

Device	Package	Shipping <sup>†</sup>					
1N63xx, G	Axial Lead (Pb-Free)	500 Units/Box					
1N63xxRL4, G	Axial Lead (Pb-Free)	1500/Tape & Reel					
ICTE-xx, G	Axial Lead (Pb-Free)	500 Units/Box					
ICTE-xxRL4, G	Axial Lead (Pb-Free)	1500/Tape & Reel					

#### **MAXIMUM RATINGS**

Rating	Symbol	Value	Unit
Peak Power Dissipation (Note 1) @ T <sub>L</sub> ≤ 25°C	P <sub>PK</sub>	1500	W
Steady State Power Dissipation @ $T_L \le 75^{\circ}C$ , Lead Length = $3/8''$ Derated above $T_L = 75^{\circ}C$	P <sub>D</sub>	5.0 20	W mW/°C
Thermal Resistance, Junction-to-Lead	$R_{ heta JL}$	20	°C/W
Forward Surge Current (Note 2) @ T <sub>A</sub> = 25°C	I <sub>FSM</sub>	200	Α
Operating and Storage Temperature Range	T <sub>J</sub> , T <sub>stg</sub>	- 65 to +175	°C

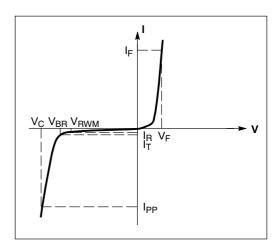
Stresses exceeding Maximum Ratings may damage the device. Maximum Ratings are stress ratings only. Functional operation above the Recommended Operating Conditions is not implied. Extended exposure to stresses above the Recommended Operating Conditions may affect device reliability.

- 1. Nonrepetitive current pulse per Figure 5 and derated above  $T_A$  = 25°C per Figure 2.
- 2. 1/2 sine wave (or equivalent square wave), PW = 8.3 ms, duty cycle = 4 pulses per minute maximum.

# **ELECTRICAL CHARACTERISTICS** (T<sub>A</sub> = 25°C unless

otherwise noted,  $V_F = 3.5 \text{ V Max.} @ I_F \text{ (Note 3)} = 100 \text{ A)}$ 

Symbol	Parameter					
I <sub>PP</sub>	Maximum Reverse Peak Pulse Current					
V <sub>C</sub>	Clamping Voltage @ I <sub>PP</sub>					
V <sub>RWM</sub>	Working Peak Reverse Voltage					
I <sub>R</sub>	Maximum Reverse Leakage Current @ V <sub>RWM</sub>					
$V_{BR}$	Breakdown Voltage @ I <sub>T</sub>					
I <sub>T</sub>	Test Current					
ΘV <sub>BR</sub>	Maximum Temperature Variation of V <sub>BR</sub>					
I <sub>F</sub>	Forward Current					
V <sub>F</sub>	Forward Voltage @ I <sub>F</sub>					



#### **Uni-Directional TVS**

#### ELECTRICAL CHARACTERISTICS (T<sub>A</sub> = 25°C unless otherwise noted, V<sub>F</sub> = 3.5 V Max. @ I<sub>F</sub> (Note 3) = 100 A)

		V <sub>RWM</sub>	I <sub>R</sub> @	Breakdown Voltage V <sub>C</sub> @ I <sub>PP</sub> (Note 6)		(Note 6)	V <sub>C</sub> (Volts) (Note 6)					
JEDEC Device <sup>†</sup> Device		(Note 4) V <sub>RWM</sub>		V <sub>BR</sub> (Note 5) (Volts)		@ I <sub>T</sub>	V <sub>C</sub>	I <sub>PP</sub>	@ I <sub>PP</sub> =	@ I <sub>PP</sub> =	$\Theta V_{BR}$	
(ON Device)	Marking	(Volts)	<b>(μΑ)</b>	Min	Nom	Max	(mA)	(Volts)	(A)	1 A	10 A	(mV/°C)
1N6373, G	1N6373	5.0	300	6.0	-	-	1.0	9.4	160	7.1	7.5	4.0
1N6374, G	1N6374	8.0	25	9.4	-	-	1.0	15	100	11.3	11.5	8.0
1N6375, G	1N6375	10	2.0	11.7	-	-	1.0	16.7	90	13.7	14.1	12
1N6376, G	1N6376	12	2.0	14.1	-	-	1.0	21.2	70	16.1	16.5	14
1N6377, G	1N6377	15	2.0	17.6	-	-	1.0	25	60	20.1	20.6	18
1N6380, G	1N6380	36	2.0	42.4	-	-	1.0	65.2	23	50.6	54.3	50
1N6381, G	1N6381	45	2.0	52.9	-	-	1.0	78.9	19	63.3	70	60
ICTE-5RLG	ICTE-5	5.0	300	6.0	-	-	1.0	9.4	160	7.1	7.5	4.0
ICTE-10RLG	ICTE-10	10	2.0	11.7	-	_	1.0	16.7	90	13.7	14.1	8.0
ICTE-12RLG	ICTE-12	12	2.0	14.1	-	_	1.0	21.2	70	16.1	16.5	12
ICTE-15RLG	ICTE-15	15	2.0	17.6	-	-	1.0	25	60	20.1	20.6	14
ICTE-18, G	ICTE-18	18	2.0	21.2	-	-	1.0	30	50	24.2	25.2	18
ICTE-36RLG	ICTE-36	36	2.0	42.4	-	_	1.0	65.2	23	50.6	54.3	26

<sup>3.</sup> Square waveform, PW = 8.3 ms, non-repetitive duty cycle.

A transient suppressor is normally selected according to the maximum working peak reverse voltage (V<sub>RWM</sub>), which should be equal to or greater than the dc or continuous peak operating voltage level.
 V<sub>BR</sub> measured at pulse test current I<sub>T</sub> at an ambient temperature of 25°C and minimum voltage in V<sub>BR</sub> is to be controlled.

<sup>6.</sup> Surge current waveform per Figure 5 and derate per Figures 1 and 2.

<sup>†</sup>The "G" suffix indicates Pb-Free package or Pb-Free packages are available.

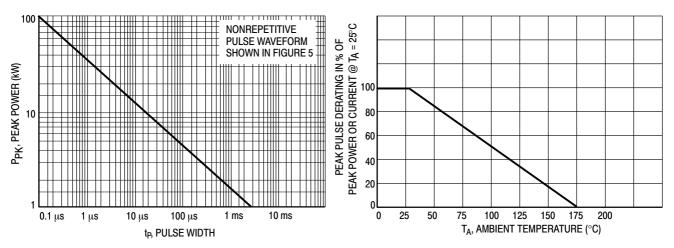


Figure 1. Pulse Rating Curve

Figure 2. Pulse Derating Curve

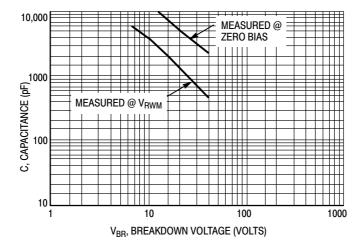


Figure 3. Capacitance versus Breakdown Voltage

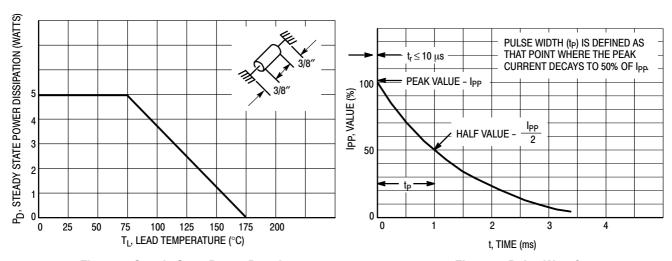
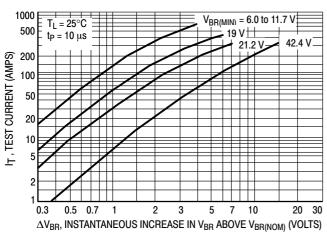


Figure 4. Steady State Power Derating

Figure 5. Pulse Waveform



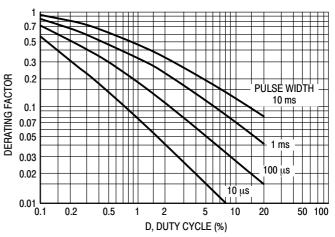


Figure 6. Dynamic Impedance

Figure 7. Typical Derating Factor for Duty Cycle

#### **APPLICATION NOTES**

#### **RESPONSE TIME**

In most applications, the transient suppressor device is placed in parallel with the equipment or component to be protected. In this situation, there is a time delay associated with the capacitance of the device and an overshoot condition associated with the inductance of the device and the inductance of the connection method. The capacitance effect is of minor importance in the parallel protection scheme because it only produces a time delay in the transition from the operating voltage to the clamp voltage as shown in Figure 8.

The inductive effects in the device are due to actual turn-on time (time required for the device to go from zero current to full current) and lead inductance. This inductive effect produces an overshoot in the voltage across the equipment or component being protected as shown in Figure 9. Minimizing this overshoot is very important in the application, since the main purpose for adding a transient suppressor is to clamp voltage spikes. These devices have excellent response time, typically in the picosecond range and negligible inductance. However, external inductive effects could produce unacceptable overshoot. Proper

circuit layout, minimum lead lengths and placing the suppressor device as close as possible to the equipment or components to be protected will minimize this overshoot.

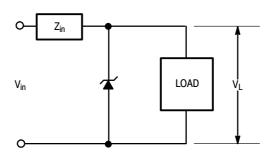
Some input impedance represented by  $Z_{in}$  is essential to prevent overstress of the protection device. This impedance should be as high as possible, without restricting the circuit operation.

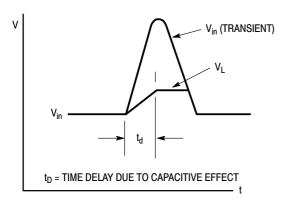
#### **DUTY CYCLE DERATING**

The data of Figure 1 applies for non-repetitive conditions and at a lead temperature of 25°C. If the duty cycle increases, the peak power must be reduced as indicated by the curves of Figure 7. Average power must be derated as the lead or ambient temperature rises above 25°C. The average power derating curve normally given on data sheets may be normalized and used for this purpose.

At first glance the derating curves of Figure 7 appear to be in error as the 10 ms pulse has a higher derating factor than the 10  $\mu$ s pulse. However, when the derating factor for a given pulse of Figure 7 is multiplied by the peak power value of Figure 1 for the same pulse, the results follow the expected trend.

# **TYPICAL PROTECTION CIRCUIT**





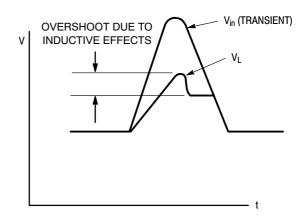
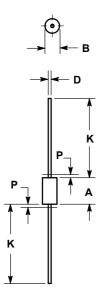


Figure 8. Figure 9.

#### PACKAGE DIMENSIONS

CASE 41A-04 ISSUE D



#### NOTES:

- DIMENSIONING AND TOLERANCING PER ANSI
  Y14.5M. 1982.

- Y14-5M, 1982.

  2 CONTROLLING DIMENSION: INCH.

  3. LEAD FINISH AND DIAMETER UNCONTROLLED IN DIMENSION P.

  4. 041A-01 THRU 041A-03 OBSOLETE, NEW STANDARD 041A-04.

	INC	HES	MILLIN	IETERS
DIM	MIN	MAX	MIN	MAX
Α	0.335	0.374	8.50	9.50
В	0.189	0.209	4.80	5.30
D	0.038	0.042	0.96	1.06
K	1.000		25.40	
Р		0.050		1 27

Littelfuse products are not designed for, and shall not be used for, any purpose (including, without limitation, automotive, military, aerospace, medical, life-saving, life-sustaining or nuclear facility applications, devices intended for surgical implant into the body, or any other application in which the failure or lack of desired operation of the product may result in personal injury, death, or property damage) other than those expressly set forth in applicable Littelfuse product documentation. Warranties granted by Littelfuse shall be deemed void for products used for any purpose not expressly set forth in applicable Littelfuse documentation. Littelfuse shall not be liable for any claims or damages arising out of products used in applications not expressly intended by Littelfuse as set forth in applicable Littelfuse documentation. The sale and use of Littelfuse products is subject to Littelfuse Terms and Conditions of Sale, unless otherwise agreed by Littelfuse.

#### Littelfuse.com